

IN THE CLAIMS

Please cancel claims 1-10, 24-26, and 28. Please add  
claim 33.

1-32. (Cancelled)

33. (New) An integrated circuit package comprising:  
a molded plastic body having a first side and a  
second side opposite the first side;  
at least four plastic posts arranged in a  
checkerboard pattern, each said post extending integrally  
from the second side of said body;  
a plurality of electrically separate metal terminals  
coating a sidewall of at least one of said posts;  
a plurality of electrically conductive circuit  
patterns on the first side of the plastic body;  
an integrated circuit including a plurality of bond  
pads, said integrated circuit mounted on the first side  
of said body and the bond pads electrically coupled to at  
least some of the circuit patterns;  
a plurality of electrically conductive vias  
extending through the plastic body from the first side to  
the second side, wherein at least some of the terminals  
on each of the at least four posts are electrically  
connected to the integrated circuit through a said  
circuit pattern and a said via; and  
an encapsulant covering the integrated circuit.